

2SA1188

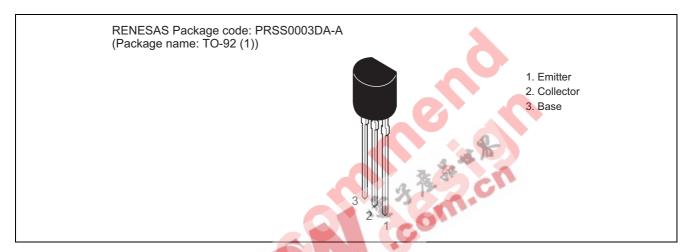
Silicon PNP Epitaxial

REJ03G0639-0300 (Previous ADE-208-1011A) Rev.3.00 Aug.10.2005

Application

Low frequency amplifier

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Rating	Unit
Collector to base voltage	V _{CBO}	-90	V
Collector to emitter voltage	V_{CEO}	-90	V
Emitter to base voltage	V_{EBO}	- 5	V
Collector current	Ic	-100	mA
Emitter current	I _E	100	mA
Collector power dissipation	P _C	400	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	−55 to +150	°C

Electrical Characteristics

 $(Ta = 25^{\circ}C)$

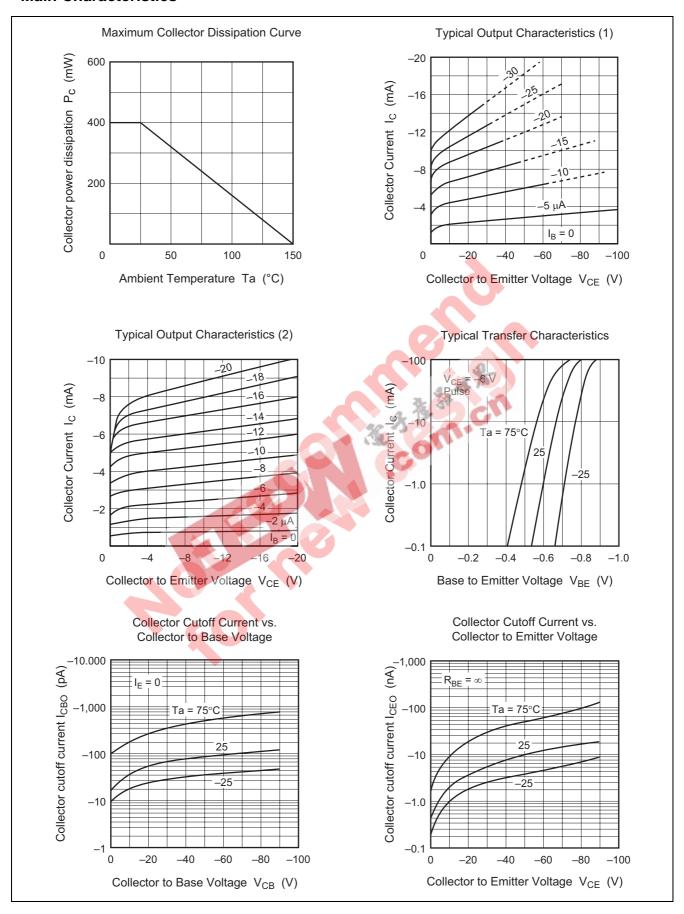
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-90	_	_	V	$I_C = -10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-90	_	_	V	$I_C = -1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	- 5	_	_	٧	$I_E = -10 \mu A, I_C = 0$
Collector cutoff current	I _{CBO}	_	_	-0.1	μΑ	$V_{CB} = -70 \text{ V}, I_E = 0$
Emitter cutoff current	I _{EBO}	_	_	-0.1	μΑ	$V_{EB} = -2 \text{ V}, I_C = 0$
DC current trnsfer ratio	h _{FE} *1	250	_	800		V _{CE} = −12 V,
						$I_C = -2 \text{ mA}^{*2}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	_	-0.05	-0.15		$I_C = -10 \text{ mA},$
						$I_B = -1 \text{ mA*}^2$
Base to emitter saturation voltage	$V_{BE(sat)}$	_	-0.7	-1.0	V	
Gain bandwidth product	f⊤	_	130	_	MHz	$V_{CE} = -6 V$,
						$I_C = -10 \text{ mA}$
Collector output capacitance	Cob		3.2	_	pF	$V_{CB} = -10 \text{ V}, I_E = 0,$
						f = 1 MHz

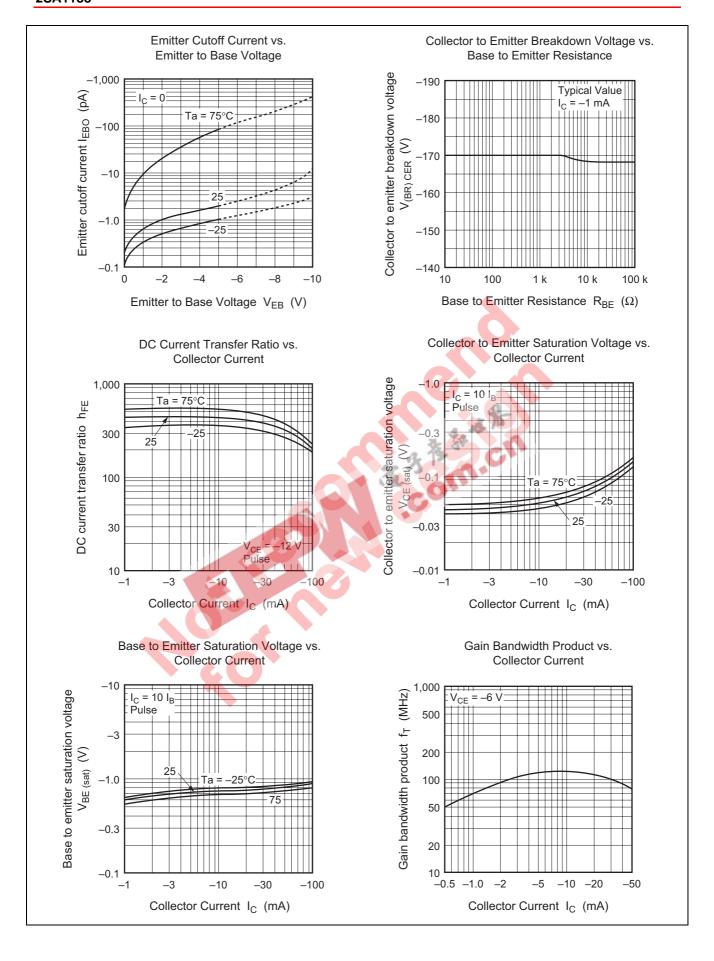
Notes: 1. The 2SA1188 is grouped by hFE as follows.

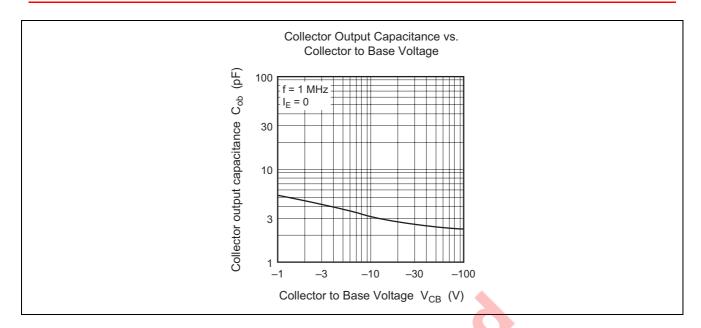
2. Pulse test

E
400 to 800

Main Characteristics

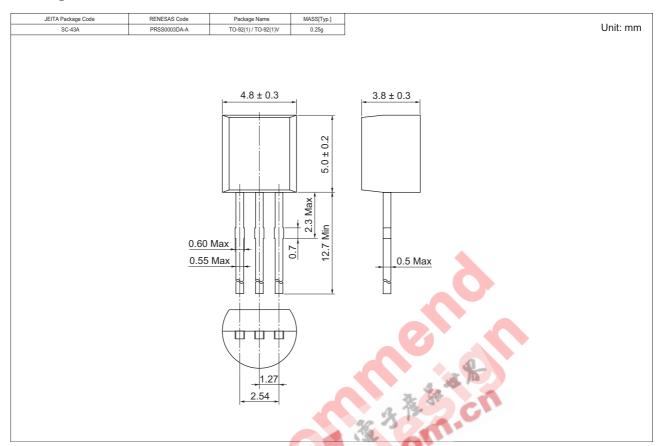








Package Dimensions



Ordering Information

Part Name	Quantity		Shipping Container
2SA1188DTZ-E	2500	Holo	l Box, Radial Taping
2SA1188ETZ-E			

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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